

QSFP28, 100G, LR4, 10km, 2xLC

**Особенности:**

- 103Gbps
- Single 3.3V Power Supply and Power dissipation < 4.5W
- Up to 10km over SMF
- Four 25Gbps EML LAN-WDM channels on transmitter side
- PIN and TIA array on the receiver side
- 4x25G electrical interface
- Duplex LC receptacles
- I2C interface with integrated Digital Diagnostic Monitoring

Области применения:

- 100GBASE-LR4 100G Ethernet

Part No.	Data Rate	Fiber	Distance *(note2)	Interface	Temp.	DDMI
QSFP28.100G.LR4 *(note1)	103Gbps	SMF	10km	LC	0°C~+70°C	Yes

Note1: also support

103Gbps Note2: Over

SMF

*The product image only for reference purpose.

Absolute Maximum Ratings

Parameter	Symbol	Min.	Max.	Unit
Storage Temperature	T _s	-40	+85	°C
Supply Voltage	V _{cc}	-0.5	3.6	V
Operating Relative Humidity	RH	5	85	%

*Exceeding any one of these values may destroy the device immediately.

Recommended Operating Conditions

Parameter	Symbol	Min.	Typical	Max.	Unit
Operating Case Temperature	T _c	0		70	°C
Power Supply Voltage	V _{cc}	3.135	3.3	3.465	V
Power Dissipation	P _D			4.5	W

Performance Specifications - Electrical

Parameter	Symbol	Min.	Typ.	Max	Unit	Notes
Transmitter						
Differential Input amplitude		150		1200	mv _{p-p}	

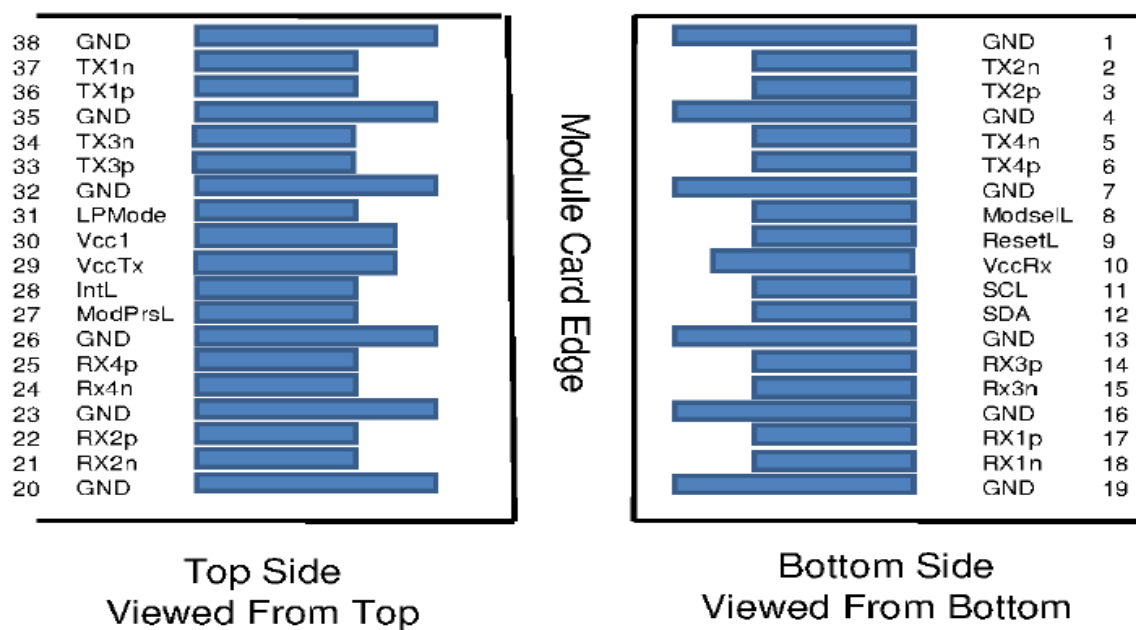
Input Impedance (Differential)	Z _{in}	85	100	115	ohms	R _{in} > 100 kohms @ DC
Receiver						
Differential output amplitude		200		1100	mV _{p-p}	
Output Impedance (Differential)	Z _{out}	85	100	115	ohms	
Output Rise/Fall Time	t _r /t _f		12		ps	10%~90%

Optical Characteristics

Parameter	Symbol	Min.	Typical	Max.	Unit
Transmitter					
Signaling Speed per Lane	BR _{AVE}		25.78		Gbps
Data Rate Variation		-100		+100	ppm
Lane_0 Center Wavelength	λ _{C0}	1294.53	1295.56	1296.59	nm
Lane_1 Center Wavelength	λ _{C1}	1299.02	1300.05	1301.09	nm
Lane_2 Center Wavelength	λ _{C2}	1303.54	1304.58	1305.63	nm
Lane_3 Center Wavelength	λ _{C3}	1308.09	1309.14	1310.19	nm
Total Average Output Power ^{*(Note3)}	P _o			10.5	dBm
Average Launch Power per Lane	P _{each}	-4.3		4.5	dBm
Average launch power of OFF transmitter per lane				-30	dBm
Optical modulation amplitude	P _{oma}	-1.3		4.5	dBm
Optical Return Loss Tolerance				20	dB
Extinction Ratio ^{*(Note4)}	ER	4			dB
Transmitter eye mask definition {X1, X2, X3, Y1, Y2, Y3} ^{*(Note4)}		IEEE 802.3 Clause 88 100Gbase-LR4			
Receiver					
Signaling Speed per Lane	BR _{AVE}		25.78		Gbps
Data Rate Variation		-100		+100	ppm
Damage threshold	R _{dam}	4.5			dBm
Lane_0 Center Wavelength	λ _{C0}	1294.53	1295.56	1296.59	nm
Lane_1 Center Wavelength	λ _{C1}	1299.02	1300.05	1301.09	nm
Lane_2 Center Wavelength	λ _{C2}	1303.54	1304.58	1305.63	nm

Lane_3 Center Wavelength	λ_{C3}	1308.09	1309.14	1310.19	nm
Average Receive Power per Lane	Rpow	-10.6		4.5	dBm
Receive Sensitivity in OMA per Lane ^{*(Note5)}	Pmin			-8.6	dBm
Optical Return Loss	ORL			-26	dB
LOS Assert	LOSA	-20.6			dBm
LOS De-Assert	LOSD			-11.6	dBm
LOS Hysteresis		0.5			dB

QSFP28 Transceiver Electrical Pad Layout



Pin Function Definitions

Pin	Logic	Symbol	Description	Plug Sequence	Notes
1		GND	Ground	1	1
2	CML-I	Tx2n	Transmitter Inverted Data Input	3	
3	CML-I	Tx2p	Transmitter Non-Inverted Data Input	3	
4		GND	Ground	1	1
5	CML-I	Tx4n	Transmitter Inverted Data Input	3	
6	CML-I	Tx4p	Transmitter Non-Inverted Data Input	3	
7		GND	Ground	1	1
8	LVTTL-I	ModSelL	Module Select	3	

9	LVTTL-I	ResetL	Module Reset	3	
10		VccRx	+3.3V Power Supply Receiver	2	2
11	LVC MOS- I/O	SCL	2-wire serial interface clock	3	
12	LVC MOS- I/O	SDA	2-wire serial interface data	3	
13		GND	Ground	1	1
14	CML-O	Rx3p	Receiver Non-Inverted Data Output	3	
15	CML-O	Rx3n	Receiver Inverted Data Output	3	
16		GND	Ground	1	1
17	CML-O	Rx1p	Receiver Non-Inverted Data Output	3	
18	CML-O	Rx1n	Receiver Inverted Data Output	3	
19		GND	Ground	1	1
20		GND	Ground	1	1
21	CML-O	Rx2n	Receiver Inverted Data Output	3	
22	CML-O	Rx2p	Receiver Non-Inverted Data Output	3	
23		GND	Ground	1	1
24	CML-O	Rx4n	Receiver Inverted Data Output	3	
25	CML-O	Rx4p	Receiver Non-Inverted Data Output	3	
26		GND	Ground	1	1
27	LVTTL-O	ModPrsL	Module Present	3	
28	LVTTL-O	IntL	Interrupt	3	
29		VccTx	+3.3V Power supply transmitter	2	2
30		Vcc1	+3.3V Power supply	2	2
31	LVTTL-I	LPMode	Low Power Mode	3	
32		GND	Ground	1	1
33	CML-I	Tx3p	Transmitter Non-Inverted Data Input	3	
34	CML-I	Tx3n	Transmitter Inverted Data Input	3	
35		GND	Ground	1	1
36	CML-I	Tx1p	Transmitter Non-Inverted Data Input	3	
37	CML-I	Tx1n	Transmitter Inverted Data Input	3	
38		GND	Ground	1	1

1: GND is the symbol for signal and supply (power) common for the QSFP28 module. All are common within the QSFP28 module and all module voltages are referenced to this potential unless otherwise noted. Connect these directly to the host board signal-common ground plane.

2: Vcc Rx, Vcc1 and Vcc Tx are the receiver and transmitter power supplies and shall be applied concurrently. Requirements defined for the host side of the Host Edge Card Connector are listed in Table 6. Recommended host board power supply filtering is shown in Figures 3 and 4. Vcc Rx Vcc1 and Vcc Tx may be internally connected within the QSFP28 Module in any combination. The connector pins are each rated for a maximum current of 500mA.

Mechanical Specifications

